

05-23-2005

COVER SHEET

U.S. Department of Commerce
Patent and Trademark Office
Attorney Docket No. 04329.3487
Attorney Customer Number: 22,852

5-11-05

To the Honorable Commis:
Please record the attachedATTN. BOX ASSIGNMENTS RECORDATION
SERVICES

1. Name of conveying party(ies):

- 1) Yoshio KASAI
- 2) Miki KAWASE
- 3) Takashi SUZUKI
- 4) Motoya KISHIDA

2. Name and address of receiving party(ies):

Name: KABUSHIKI KAISHA TOSHIBA

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

Internal Address:

3. Nature of conveyance:

Street Address: 1-1, Shibaura 1-chome, Minato-ku,
Tokyo 105-8001, Japan☒ Assignment ☐ Merger

City:

☐ Security Agreement ☐ Change of Name

State:

Zip Code:

☐ Other:

Additional name(s) & Address(es) attached?

Execution Date:

- 1) February 28, 2005
- 2) March 18, 2005
- 3) March 4, 2005
- 4) March 4, 2005

☐ Yes☒ No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application:

A. Patent Application Number(s):

11/061,531

B. Patent Number(s):

Additional numbers attached?

☐ Yes☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

6. Total number of applications and registrations involved:
1

7. Total fee (37 CFR 3.41): \$40

☒ Enclosed (Please charge deficiency to deposit account)☐ Authorized to be charged to deposit accountInternal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT
& DUNNER, L.L.P.

Street Address: 901 New York Avenue, NW

City: Washington, D.C.

State: Zip: 20001-4413

8. Deposit Account No.: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

05/20/2005 BYRNE 00000184 11061531

01 FC:8021

Richard V. Burgujian 40.00 OP
Reg. No. 31,744

Signature

May 18, 2005

Date

Total number of pages including cover sheet, attachments and documents: 3

APG039295-USA-A
(04S1762)

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE

PATENT
REEL: 016574 FRAME: 0360

A S S I G N M E N T

APG039295-USA-A
(04S1762)

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